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**UPDATE CHANGE NOTIFICATION # 20473**

Generic Copy

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**Issue Date:** 01-Aug-2014

**TITLE:** To correct the top mark code stated in FPCN20473

**PROPOSED FIRST SHIP DATE:** 01-Aug-2014 or earlier with customer approval

**AFFECTED CHANGE CATEGORY(S):** ON Semiconductor Assembly Site

**SAMPLES:** Contact your local ON Semiconductor Sales Office or Mike Begonia  
<[mike.begonia@onsemi.com](mailto:mike.begonia@onsemi.com)>

**FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:**  
Contact your local ON Semiconductor Sales Office or Mike Begonia  
<[mike.begonia@onsemi.com](mailto:mike.begonia@onsemi.com)>

**NOTIFICATION TYPE:**

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <[quality@onsemi.com](mailto:quality@onsemi.com)>.

**DESCRIPTION AND PURPOSE:**

FPCN20473 indicates marking change as below:

<p><b><u>CHANGED PART IDENTIFICATION:</u></b></p> <p>Marking of the month date codes:</p> <p>Seremban Malaysia assembled devices: M</p> <p>ASE Shanghai assembled devices: ☒</p>
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TO:

The location of the assembly sites can be identified by the marking of the date code:  
Seremban Facility = R plus date code  
ASE Shanghai = AS plus date code

**List of affected General Parts:**

NIS5132MN1TXG  
NIS5132MN2TXG  
NIS5132MN3TXG  
NIS5135MN1TXG  
NIS5135MN2TXG  
NIS5232MN1TXG